Tender No:				
KDU/PRO/CAP/ 132 /2021	General Sir John Kotelawala Defence University, KandawalaEstate, Ratmalana, Sri Lanka. T: Phone: 2632028, 2622995 Fax: 2622504, 2623599 Web:www.kdu.lk			
	14 / 03 / 2022			
INVITATION TO BID AND GENERAL CONDITIONS	S OF TENDER			
	elawala Defence University, as the Chairman, Department Procurement apply of item/s listed in the schedule in Annex "A". The relevant			
2. CLOSING DATE & TIME . The to the closing time of the tender will be rejected & unopened s	ender will close at 1000 hrs. on $05 / 04 / 2022$. Any Bid submitted after such bids will be returned to the bidder.			
3. VALIDITY OF BID. The bid submidate of closing of tender.	tted under this tender must be valid for a period of 120 days from the			
4. <u>BID BOND / GUARANTEE.</u> (a) If the quoted bid value exceeds Rs: 2,000,000.00, such Bids should be accompanied with 1% of Bid Value an "on demand" and "unconditional" Bid Bond/Guarantee for a sum of Rs:				
(b) Submission of insufficient Bid Bond/Guarantee value or period will be considered as a " major deviation " and such offer will not be considered for further procurement action and will be rejected.				
5. <u>VALUE ADDED TAX</u> . The Bidders who bid for locally delivered items must have the VAT registration. The VAT portion must be shown separately in the price schedule in Annex "A" and VAT registration number must be indicated. If the quoted item is exempted from VAT or Bidding Company is not liable for VAT, reference number and date of relevant Act number/Gazette notification/a certificate (as applicable) <u>issued for the current financial year</u> from the Commissioner General of Inland Revenue to that effect should be submitted along with the Bid.				
6. BID SUBMISSION. The bidder must duly sign at the last page (before Annexes) of this document indicating the name of the signatory and the name of the company & place the company common seal to confirm the acceptance of tender conditions. The Bid/s that do not include authorized signature will be rejected. The Bid/s duly signed by the bidder enclosed and sealed in an appropriate cover addressed to the following address should be sent by registered post or could be deposited in the appropriate tender box placed at General Sir John Kotelawala Defence University, Kandawala Estate, Ratmalana (at the Main Entrance of General Sir John Kotelawala Defence University) on or before the time & date specified for the closing of tender. The tender reference number, date & time of closing tender should be indicated & underlined at the top left corner of the envelop.				
Tender Ref No :	The Chairman, Department Procurement Committee, General Sir John Kotelawala Defence University			

7. The Bid/s must be submitted in the attached schedule of prices in Annex "A" as applicable. However, bidders could use similar formats prepared with their own letter heads with all the details mentioned therein and submit in three copies along with duly signed copy of a General Conditions of tender. The Bid/s must contain Technical Literature, Pamphlets, Drawings and Quality Standard Certificate etc necessary to determine characteristics of items offered and in case of Machinery/Vehicles & Equipment, servicing and workshop data/after sales service, back up facilities or any other facilities provided by the supplier.

Sri Lanka.

Kandawala Estate, Ratmalana,

8. SUBMISSION OF SAMPLES/PAYMENT OF TESTING CHARGES.

When it is required to submit samples, <u>every offer</u> must be accompanied with pre - marked samples. The marking of samples <u>indicating the Bidder & Offer number</u> must be done and the samples must be handed over to the officer at same place where tender box is placed <u>on or before the closing date & time of the Bid</u>. Samples submitted after closing time of the Bid will be rejected. The documents such as Air Way Bills etc, will not be accepted in place of samples. When the testing charges are required to be paid, bidders shall pay testing charges separately <u>for all offers</u> indicated in their bid/s.

(1	.)	Samples.	Please submit	samples
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(2) **Testing Charges**. A sum of Rs. **per offer** must be paid to the Bursar of KDU, prior to the submission of bid and a copy of the receipt must be annexed to the bid. It is the responsibility of bidder to inform the Cashier of the Account Office to note the tender number on the receipt issued for such payments.

8. <u>BID OPENING</u>. All duly received bids <u>will be opened immediately after the scheduled closing time of Bids at the same venue</u>. Bidders or their accredited agents could be present at the time of opening of bids.

9. PRICES.

For locally delivered items (including locally manufactured items & foreign items imported by the bidders) price must be quoted in Sri Lankan Rupees, inclusive of all charges for delivery of items to General Sir John Kotelawala Defence University Ratmalana, Faculty of Allied Health Science (FAHS) Werahera and University Hospital Werahera or Southern Campus Sooriyawewa. Unit price, VAT and Total price should be clearly indicated in schedule in Annex "A". Other than VAT, all other type of taxes (eg: NBT, BTT, etc.) should not be indicated separately and should be included in unit price.

- Invitation to Bids are circulated a mong the registered suppliers with RESTRICTED TENDERS. Ministry of Defence (MOD), only bids submitted by registered suppliers will be allowed for consideration. However, Chairman, Department Procurement Committee reserves the right to invite the bids from multiple combinations of Procurement Methods as stipulated in Chapter III of the Government Procurement Guideline, 2006 to ensure highest competitiveness.
- PERFORMANCE BOND/GUARANTEE. A successful bidder shall furnish Bond/Guarantee in the form of "On Demand" & "Unconditional" Bank/Insurance Guarantee for a sum equivalent to 10% of the contract value for every contract that exceeds Rs. 2,000,000.00 or equivalent amount in foreign currency through a recognized Commercial Bank registered in Sri Lanka or through an Insurance Company authorized by the Insurance Board of Sri Lanka to issue such Performance Guarantee for this purpose, within two weeks from the date of notification of award. The proceeds of the Performance Bond/Guarantee shall be payable to the Vice Chancellor of the General Sir John Kotelawala Defence University as compensation for any loss resulting from the supplier's failure to complete his performance obligations under the contract. If the contracted supplier fails to deliver the items on time or fails to complete the works as per the agreed contract, THE TOTAL VALUE OF THE PERFORMANCE BOND/GUARANTEE will be forfeited. If only partial delivery is made during the agreed contract period, the corresponding value percentage of undelivered quantity from the Performance Bond/Guarantee will be forfeited.
- SIGNING OF CONTRACT. The notification of award will be transmitted to the successful bidder by post, by fax or e-mail. This notification constitutes the formation of the contract. The successful bidder should submit his written acceptance for the award and performance bond / guarantee (For awards over Rs. 500,000.00 without VAT) within 14 days of receipt of such notification. Upon acceptance of the award and furnishing of the Performance Bond/Guarantee, the successful bidder will have to enter into a formal contract with the Vice Chancellor of the General Sir John Kotelawala Defence University by signing the Contract.
- 13. Preference will be given for early delivery. In case of bulk supplies for locally manufactured items, the delivery of total quantity must be completed within 120 days of signing of contract, unless mutually agreed for extended delivery period with General Sir John Kotelawala Defence University. The bidder/s must indicate the proposed delivery schedule in Annex "D". In the event of placing a purchase order with the successful bidder, the total quantity so ordered must be supplied as one consignment unless part deliveries are agreed upon in the contract. The deliveries not made as per agreed delivery schedule will be considered as bad performances by the suppliers and no extended delivery period will be authorized. Under extreme unavoidable conditions too, the Chairman, Department Procurement Committee (Vice Chancellor of the General Sir John Kotelawala Defence University) reserves the right to grant or refuse delivery period extensions only within the current financial year with or without liquidated claim for delayed deliveries and that decision will be final.
- 14. LIOUIDATED DAMAGES. In case of delivery period extensions requested by the successful bidder, a sum equivalent to 1% of the total value of the delayed supply per delay of one week or part thereof may be deducted from the payment due to the supplier from the General Sir John Kotelawala Defence University as liquidated damages up to the maximum limit of 12% of the total value of delayed supplies.
- PAYMENT TERMS FOR LOCALLY DELIVERED ITEMS. Payment will be made after acceptance of items which should be subjected to a pre-acceptance inspection/testing by General Sir John Kotelawala Defence University authorities. The delivery made to the General Sir John Kotelawala Defence University should not be considered as quantities taken over by General Sir John Kotelawala Defence University until items are properly accepted after pre-acceptance inspection. Any item that does not conform to the specifications or already approved sample will be rejected & it is the responsibility of the supplier to remove them from General Sir John Kotelawala Defence University stores/premises within 07 working days of such intimation (either verbal or written) at his own cost and replace them with items conforming to specification within one month of such rejection. The bidder shall allow approximately 60-90 days' period of credit from the date of acceptance of items for Account Office, General Sir John Kotelawala Defence University to obtain liquid cash from General Treasury & release the payment.
- RIGHTS OF THE PROCUREMENT COMMITTEE. The Department Procurement Committee reserve the right to accept or reject whole or part of this tender and their decision will be final. The successful bidders will be notified. Information with regard to rejected or unsuccessful bids will not be communicated.

Thanking You,

Yours faithfully,

the contract,

I/We agree to abide by the conditions of tender and undertak	SA Kumpranayake SA Kumaranaya For Vice Chancellor General Sir John Kotelawala Defence University ke to supply the items as per delivery schedule mentioned in
in the event of an order been placed with me/my firm/compa	
Signature	
Name of the Company/Bidder	
Date :	Company seal

DATE

SCHEDULE OF PRICES FOR LOCALLY DELIVERED ITEMS

S/N	ITEMS	DENO	QTY	PRICE EACH SLRS	TOTAL PRICE SLRS
	PURCHASE OF LAB EQUIPMENT FOC (ELECTRICAL ITEMS)	FOR			
01	Laptop Computers	Nos	07		
02	Printer	Nos	02		
03	Desktop Computers	Nos	20		
04	Improve Performance of the HPC C	luster			
i	Storage Servers	Nos	02		
ii	10G BASE-T SFT +RJ45 XCVR Con	vertors Nos	08		
iii	KVM Switch	Nos	01		
	As Per the Attached Specifications				
	TOTAL				
	DISCOUNT				
	TOTAL(AFTER DISCOUNT)				
	VAT %				
	GRAND TOTAL				
(C) PLACE OF DELIVERY - SIR KA		 			
		CERTIFICATE	/ VAT	EXEMPTION	NENT REGISTRATION LETTER ISSUED BUT TO BE ATTACHE
		SIR JOHN I	KOTEL. STATE	AWALA DEI C, RATMALAN	O TO THE "GENERA FENCE UNIVERSITY NA ALONG WITH TH INVOICE.
(D)	Any queries / information with r from Officer Commanding Logi Defence University through e-mai during working hours.	stics Services	office	at General S	Sir John Kotelawal
	NOTE: UNIT PRICE AND TOT THE TENDER, IF NOT QUOTA				ATED CLEARLY I
	ADDRESS		•••••		Company Seal
	- 1.5. I DD-000	••••••			
(F)	Bid Reference: KDU/PRO/CAP/ 1	132/2021			

(E) Bid Reference: KDU/PRO/CAP/ 132/2021

	Ι	Intel® Core™ i7 Processor (10th Gen or Above)	1000	
	01	16GB Ram (DDR 4)	27	
	Oi		-	
		2TB Hard Drive		
	Ι.	256 GB SSD		
		2GB VGA (NVIDIA Graphics with GPU Support)		
	1.	15.6 LED		
	1	Web Cam		10
		Bluetooth Wifi		
	1	Keyboard English International		
	1	Touch Pad Mouse		
	l	Optical Drive (DVD RW)	ł	
		Charger	ŀ	
			•	All discussions by
		Microsoft Windows 10 Professional		
		Hi-speed USB 2.0,	 ;	
		In-speed CSB 2.0,	02	
	02	Wireless/Wired LAN Pictbridge, Direct Wireless		
		Witeless whed LAM Fictionage, Direct witeless		A
]	Warranty - 03 Years		A 100 (100 (100 (100 (100 (100 (100 (100
		warranty - 03 rears		
			20 .	
	'	Processor: Intel(R) Core (TM) i7-8700 CPU @ 3.20GHz	20 .	
7	03	TI I DECOGD OF	ľ	
		Hard Drive: 256SSD (Primary) + 1TB Hard		
	l	(Secondary)		
		RAM Memory: 16GB		
		Display:19.5 - inch		
		Graphics Card: Nvidia GeForce GTX 1050 TI (4GB)	Ι΄	
		Operating System : Windows 10		
	1 .	DVD-RW: Yes		
		Keyboard Mouse :USB		A Stratutes
		Networking: LAN: Intel® I210-T1 PCIe® GbF; Realtek		
		RTL8111HSH-CG GbE /WLAN: Intel® Dual Band		
		Wireless-AC 9560 802.11ac (2x2) and Bluetooth® 5 M.2		
		W7		
		Warranty:3 years comprehensive		·
		Tan di		
		(6)	02	
			02	
	04	Form Factor: 1U or 2U or more Rack Mount	02	
	04	Form Factor: 1U or 2U or more Rack Mount Processors: 2 x Intel® Xeon® Gold Processor or better	02	
	04	Form Factor: 1U or 2U or more Rack Mount Processors: 2 x Intel® Xeon® Gold Processor or better RAID Controller: RAID SATA 6Gb/s - RAID 0, 1, 5, 6, 10,	02	
	04	Form Factor: 1U or 2U or more Rack Mount Processors: 2 x Intel® Xeon® Gold Processor or better RAID Controller: RAID SATA 6Gb/s - RAID 0, 1, 5, 6, 10, JBOD or better	02	
	04	Form Factor: 1U or 2U or more Rack Mount Processors: 2 x Intel® Xeon® Gold Processor or better RAID Controller: RAID SATA 6Gb/s - RAID 0, 1, 5, 6, 10, JBOD or better Storage: 24 x 2TB (32 TB Storage) 7.2K RPM	02	
	04	Form Factor: 1U or 2U or more Rack Mount Processors: 2 x Intel® Xeon® Gold Processor or better RAID Controller: RAID SATA 6Gb/s - RAID 0, 1, 5, 6, 10, JBOD or better Storage: 24 x 2TB (32 TB Storage) 7.2K RPM RAM: 256 GB Ram DDR4	02	
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and by -----

In the capacity of -----

Seal (where applicable)

			<u>SPECII</u>	<u>MEN FORM C</u>	<u> F BID SE</u>	CCURITY
firmly	e compa bound	ny) who	se registered office	is at	(he	nafter called "the Bidder") and We (name of bank or
of	mselves Wherea	their suc s the aut	cessors and assigns hority has invited th	jointly and sevene Tender and o	erally by tl ther person	nose presents. ns to compete tenders in similar terms for the supply and to
called "t honour o	the Bid") certain ol) in acco oligation	rdance with such in	vitation, the Bo	ond shall p	proposes to submit to the Authority a Bid (hereafter provide security to the Authority that the Bidder will cordance with the following conditions.
	(a)	That it	shall remain in full	force and effect	until the e	earliest of
						date), the date stipulated by the Authority for the ate above notified to the Authority by the Bidder and
						by the Authority, the date upon which the Bidder accordance with the terms of the contract thereby
	(b) Bond up		to this Bond being pt of first written de			he Surety shall pay the full amount specified in this stating that.
		(i)	The Bidder has w	ithdrawn his Te	nder durin	g the validity of this Bond, or
		(ii) terms o				ance security to the Authority in accordance with the imation of award of the Tender.
	concerni	ing the T				of forgiveness in or in respect of neither any matter bjection from the bidder shall in any way release the
the Auth	ority sha	all return	his Bond shall not be the same to the Bid be governed by the	lder.		rity and upon its ceasing to be in full force and effect
	I exec	cuted as a	a deed on this () day of () 20 ()
	For and	on beha	lf of the Bidder			For and on behalf of the Surety
						Signed by
		•	·f			In the capacity of

and by -----

In the capacity of -----

Seal (where applicable)

DELIVERY SCHEDULE (IT IS MANDATORY TO FILL THE FOLLOWING SCHEDULE BY THE BIDDER) TENDER NO: QTY :..... **DURATION** QTY EX STOCK QTY (WITHIN 01 WEEK) 01MONTH 02 MONTHS 03 MONTHS 04 MONTHS **TOTAL** NAME OF THE BIDDER : SIGNATURE OF BIDDER DATE :

::

COMPANY SEAL